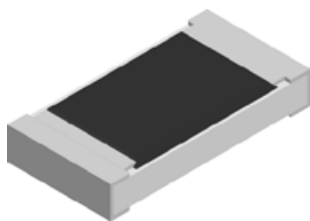




Lead (Pb)-Bearing Thick Film, Rectangular, Trimmable Chip Resistors



FEATURES

**HALOGEN
FREE**

- Can be trimmed to the required value after insertion
- For applications in precision circuitry where relative tolerances can be compensated by trimming
- Lead (Pb)-bearing termination plating on Ni barrier layer
- Metal glaze on high quality ceramic
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

STANDARD ELECTRICAL SPECIFICATIONS

MODEL	CASE SIZE INCH	CASE SIZE METRIC	POWER RATING P_{70} W	LIMITING ELEMENT VOLTAGE U_{max} AC _{RMS} /DC V	TEMPERATURE COEFFICIENT ppm/K	TOLERANCE %	RESISTANCE RANGE Ω	SERIES
D10/CRCW0402-TR	0402	RR 1005M	0.063	50	± 100 ± 200	$\pm 10, \pm 15, \pm 20,$ + 0/- 10, + 0/- 20, + 0/- 30	10 to 10M 0.47 to 10M	E24
D11/CRCW0603-TR	0603	RR 1608M	0.10	75	± 100 ± 200	$\pm 10, \pm 15, \pm 20,$ + 0/- 10, + 0/- 20, + 0/- 30	10 to 10M 0.47 to 10M	E24
D12/CRCW0805-TR	0805	RR 2012M	0.125	150	± 100 ± 200	$\pm 10, \pm 15, \pm 20,$ + 0/- 10, + 0/- 20, + 0/- 30	10 to 10M 0.47 to 10M	E24
D25/CRCW1206-TR	1206	RR 3216M	0.25	200	± 100 ± 200	$\pm 10, \pm 15, \pm 20,$ + 0/- 10, + 0/- 20, + 0/- 30	10 to 10M 0.47 to 10M	E24
CRCW1210-TR	1210	RR 3225M	0.50	200	± 100 ± 200	$\pm 10, \pm 15, \pm 20,$ + 0/- 10, + 0/- 20, + 0/- 30	10 to 4.7M	E24
CRCW2010-TR	2010	RR 5025M	0.75	400	± 100 ± 200	$\pm 10, \pm 15, \pm 20,$ + 0/- 10, + 0/- 20, + 0/- 30	10 to 4.7M	E24
CRCW2512-TR	2512	RR 6332M	1.0	500	± 100 ± 200	$\pm 10, \pm 15, \pm 20,$ + 0/- 10, + 0/- 20, + 0/- 30	10 to 4.7M	E24

Notes

- These resistors do not feature a limited lifetime when operated within the limits of rated dissipation, permissible operating voltage and permissible film temperature. However, the resistance typically increase due to the resistor's film temperature over operating time, generally known as drift. The drift may exceed the stability requirements of an individual application circuit and thereby limits the functional time.
- Marking: None
- Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.

TECHNICAL SPECIFICATIONS

PARAMETER	UNIT	D10/ CRCW0402-TR	D11/ CRCW0603-TR	D12/ CRCW0805-TR	D25/ CRCW1206-TR	CRCW1210-TR	CRCW2010-TR	CRCW2512-TR
Rated dissipation P_{70} ⁽¹⁾	W	0.063	0.1	0.125	0.25	0.50	0.75	1.0
Operating voltage U_{max} . AC _{RMS} /DC	V	50	75	150	200	200	400	500
Insulation voltage U_{ins} . (1 min)	V	75	100	200	300	300	300	300
Insulation resistance	Ω	> 10^9						
Operating temperature range	$^{\circ}\text{C}$	-55 to + 55						
Weight	mg	0.65	2	5.5	10	16	25.5	40.5

Note

- ⁽¹⁾ The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 $^{\circ}\text{C}$ is not exceeded.



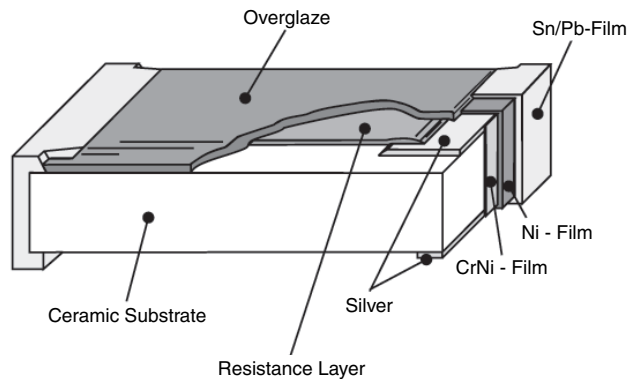
PART NUMBER AND PRODUCT DESCRIPTION																	
Part Number: CRCW080524R0KKTATR																	
C	R	C	W	0	8	0	5	2	4	R	0	K	K	T	A	T	R
MODEL		RESISTANCE		TOLERANCE		TCR		PACKAGING		SPECIAL							
CRCW0402 CRCW0603 CRCW0805 CRCW1206 CRCW1210 CRCW2010 CRCW2512		R = decimal K = thousand M = million		K = ± 10 % L = ± 15 % M = ± 20 % U = + 0 %/- 10 % V = + 0 %/- 20 % W = + 0 %/- 30 %		K = ± 100 ppm/K N = ± 200 ppm/K		TA, TB, TC, TD, TE, TF, TG, TH		Up to 2 digits TR = customer trimmable							
Product Description: CRCW0805-TR 100 24R 10 % RT1																	
CRCW0805-TR		100		24R		10 %		RT1									
MODEL		TCR		RESISTANCE		TOLERANCE		PACKAGING									
CRCW0402-TR CRCW0603-TR CRCW0805-TR CRCW1206-TR CRCW1210-TR CRCW2010-TR CRCW2512-TR		± 100 ppm/K ± 200 ppm/K		24R = 240 3K9 = 390 1M0 = 105		± 10 % ± 15 % ± 20 % + 0 %/- 10 % + 0 %/- 20 % + 0 %/- 30 %		RT1, RT5, RT6, RT7, RF4, R02, R67, R82									

PACKAGING								
MODEL	CODE	QUANTITY	CARRIER TAPE	WIDTH	PITCH	REEL DIAMETER		
CRCW0402-TR	TD = RT7	10 000	Paper tape acc. to IEC 60068-3 Type I	8 mm	2 mm	180 mm/7"		
	TE = RF4	50 000				330 mm/13"		
CRCW0603-TR	TA = RT1	5000			8 mm	4 mm	180 mm/7"	
	TB = RT5	10 000					285 mm/11.25"	
	TC = RT6	20 000			8 mm	4 mm	330 mm/13"	
	TA = RT1	5000					180 mm/7"	
CRCW0805-TR	TB = RT5	10 000		285 mm/11.25"				
	TC = RT6	20 000		330 mm/13"				
CRCW1206-TR	TA = RT1	5000		8 mm			4 mm	180 mm/7"
	TB = RT5	10 000						285 mm/11.25"
	TC = RT6	20 000		8 mm	4 mm	330 mm/13"		
	TA = RT1	5000				180 mm/7"		
CRCW1210-TR	TB = RT5	10 000	285 mm/11.25"					
	TC = RT6	20 000	330 mm/13"					
CRCW1218-TR	TK = RT9	4000	Blister tape acc. to IEC 60068-3 Type II			12 mm	4 mm	180 mm/7"
CRCW2010-TR	TF = R02	4000				12 mm	4 mm	180 mm/7"
CRCW2512-TR	TG = R67	2000		12 mm	8 mm	4 mm	180 mm/7"	
	TH = R82	4000						



DIMENSIONS												
SIZE		DIMENSIONS in millimeters					SOLDER PAD DIMENSIONS in millimeters					
INCH	METRIC	L	W	H	T1	T2	REFLOW SOLDERING			WAVE SOLDERING		
							a	b	l	a	b	l
0402	1005	1.0 ± 0.05	0.5 ± 0.05	0.35 ± 0.05	0.25 ± 0.10	0.2 ± 0.1	0.4	0.6	0.5			
0603	1608	1.55 ^{+0.10} _{-0.05}	0.85 ± 0.1	0.45 ± 0.05	0.3 ± 0.2	0.3 ± 0.2	0.5	0.9	1.0	0.9	0.9	1.0
0805	2012	2.0 ^{+0.20} _{-0.10}	1.25 ± 0.15	0.45 ± 0.05	0.3 ^{+0.20} _{-0.10}	0.3 ± 0.2	0.7	1.3	1.2	0.9	1.3	1.3
1206	3216	3.2 ^{+0.10} _{-0.20}	1.6 ± 0.15	0.55 ^{+0.05} _{-0.10}	0.45 ± 0.2	0.4 ± 0.2	0.9	1.7	2.0	1.1	1.7	2.3
1210	3225	3.2 ± 0.2	2.5 ± 0.2	0.55 ± 0.05	0.45 ± 0.2	0.4 ± 0.2	0.9	2.5	2.0	1.1	2.5	2.2
2010	5025	5.0 ± 0.15	2.5 ± 0.15	0.6 ± 0.1	0.6 ± 0.2	0.6 ± 0.2	1.0	2.5	3.9	1.2	2.5	3.9
2512	6332	6.3 ± 0.2	3.15 ± 0.15	0.6 ± 0.1	0.6 ± 0.2	0.6 ± 0.2	1.0	3.2	5.2	1.2	3.2	5.2

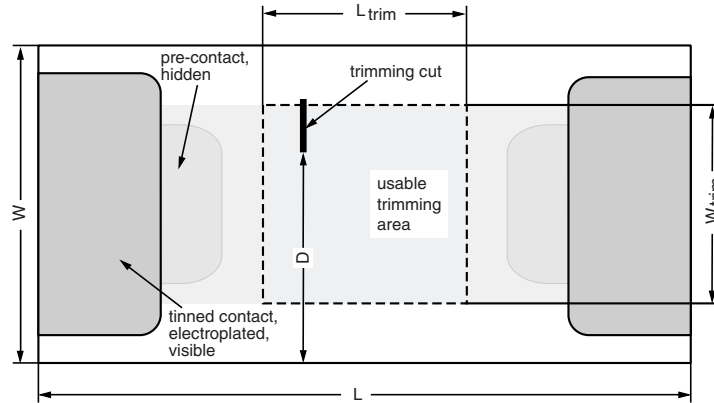
TRIMMING INSTRUCTIONS



YAG-Laser:
 Maximum trimming factor = 1.6 for an I-cut and 1.8 for a L-cut.
 Double cut: Distance between two cuts = 0.5 mm min.
 The laser-cut should be protected with epoxy resins.



PERMISSIBLE TRIMMING AREA

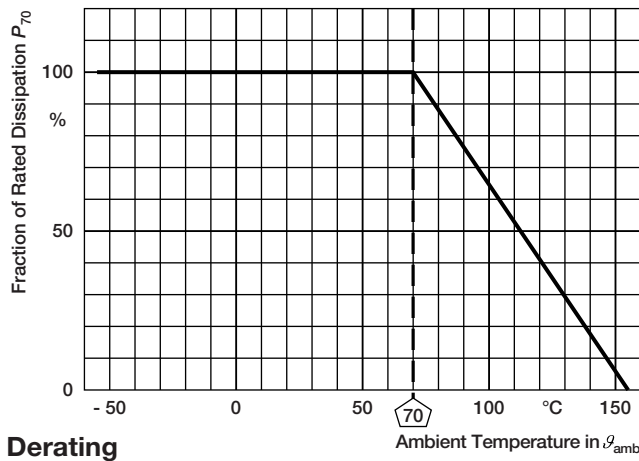


DIMENSIONS OF THE PERMISSIBLE TRIMMING AREA in millimeters					
MODEL	L	W	L _{trim}	W _{trim}	D
D10/CRCW0402-TR ⁽¹⁾	1.0	0.5	≤ 0.25	0.27	≥ 0.25
D11/CRCW0603-TR ⁽¹⁾	1.55	0.85	≤ 0.425	0.5	≥ 0.425
D12/CRCW0805-TR	2.0	1.25	≤ 0.625	0.85	≥ 0.625
D25/CRCW1206-TR	3.2	1.6	≤ 0.8	1.0	≥ 0.8
CRCW1210-TR	3.2	2.5	≤ 1.25	1.6	≥ 1.25
CRCW2010-TR	5.0	2.5	≤ 1.25	1.9	≥ 1.25
CRCW2512-TR	6.3	3.15	≤ 1.575	2.4	≥ 1.575

Note

⁽¹⁾ Single cut only.

DERATING





TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR) ⁽¹⁾	
			Stability for product types:	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER
			D/CRCW-TR	10 Ω to 10 M Ω	0.47 Ω to 10 M Ω
4.5	-	Resistance	-	$\pm 1 \%$	$\pm 5 \%$
4.13	-	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R} \leq 2 \times U_{max.}$; Duration acc. to style	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$
4.17.2	58 (Td)	Solderability	Solder bath method; Sn60Pb40 non-activated flux; (235 \pm 5) $^{\circ}$ C (2 \pm 0.2) s	Good tinning ($\geq 95 \%$ covered) no visible damage	
			Solder bath method; Sn96.5Ag3Cu0.5 or Sn99.3Cu0.7 non-activated flux; (245 \pm 5) $^{\circ}$ C or (250 \pm 5) $^{\circ}$ C (3 \pm 0.3) s	Good tinning ($\geq 95 \%$ covered) no visible damage	
4.8.4.2	-	Temperature coefficient	(20/- 55/20) $^{\circ}$ C and (20/125/20) $^{\circ}$ C	± 100 ppm/K	± 200 ppm/K
4.19	14 (Na)	Rapid change of temperature	30 min. at -55 $^{\circ}$ C; 30 min. at 125 $^{\circ}$ C		
			5 cycles	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$
			1000 cycles	$\pm (1 \% R + 0.05 \Omega)$	$\pm (1 \% R + 0.05 \Omega)$
4.23	-	Climatic sequence:	-		
4.23.2	2 (Ba)	Dry heat	125 $^{\circ}$ C; 16 h		
4.23.3	30 (Db)	Damp heat, cyclic	55 $^{\circ}$ C; $\geq 90 \%$ RH; 24 h; 1 cycle		
4.23.4	1 (Aa)	Cold	-55 $^{\circ}$ C; 2 h	$\pm (1 \% R + 0.05 \Omega)$	$\pm (2 \% R + 0.1 \Omega)$
4.23.5	13 (M)	Low air pressure	1 kPa; (25 \pm 10) $^{\circ}$ C; 1 h		
4.23.6	30 (Db)	Damp heat, cyclic	55 $^{\circ}$ C; $\geq 90 \%$ RH; 24 h; 5 cycles		
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R}$		
4.25.1	-	Endurance at 70 $^{\circ}$ C	$U = \sqrt{P_{70} \times R} \leq U_{max.}$; 1.5 h on; 0.5 h off;		
			70 $^{\circ}$ C; 1000 h	$\pm (1 \% R + 0.05 \Omega)$	$\pm (2 \% R + 0.1 \Omega)$
			70 $^{\circ}$ C; 8000 h	$\pm (2 \% R + 0.1 \Omega)$	$\pm (4 \% R + 0.1 \Omega)$
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method (260 \pm 5) $^{\circ}$ C; (10 \pm 1) s	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$



TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR) ⁽¹⁾	
			Stability for product types:	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER
			D/CRCW-TR	10 Ω to 10 M Ω	0.47 Ω to 10 M Ω
4.24	78 (Cab)	Damp heat, steady state	(40 \pm 2) $^{\circ}$ C; (93 \pm 3) % RH; 56 days	\pm (1 % R + 0.05 Ω)	\pm (2 % R + 0.1 Ω)
4.25.3	-	Endurance at upper category temperature	155 $^{\circ}$ C, 1000 h	\pm (1 % R + 0.05 Ω)	\pm (2 % R + 0.1 Ω)

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2-x, environmental test procedures

Packaging of components is done in paper tapes according to IEC 60286-3.



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